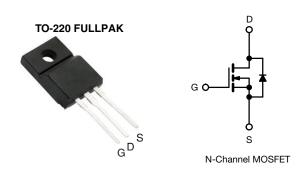
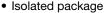


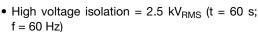
## **Power MOSFET**



PRODUCT SUMMARY				
V <sub>DS</sub> (V)	60			
R <sub>DS(on)</sub> (Ω)	V <sub>GS</sub> = 10 V 0.20			
Q <sub>g</sub> (Max.) (nC)	11			
Q <sub>gs</sub> (nC)	3.1			
Q <sub>gd</sub> (nC)	5.8			
Configuration	Single			

### **FEATURES**







- Sink to lead creepage distance = 4.8 mm
- 175 °C operating temperature
- · Dynamic dv/dt rating
- Low thermal resistance
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **DESCRIPTION**

Third generation power MOSFETs from Vishay provides the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost effectiveness.

The TO-220 FULLPAK eliminates the need for additional insulating hardware in commercial-industrial applications. The molding compound used provides a high isolation capability and a low thermal resistance between the tab and external heatsink. This isolation is equivalent to using a 100 micron mica barrier with standard TO-220 product. The FULLPAK is mounted to a heatsink using a single clip or by a single screw fixing.

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free	IRFIZ14GPbF

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			$V_{DS}$	60	V
Gate-source voltage			$V_{GS}$	± 20	V
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	1	8.0	
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	5.7	Α
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	32	
Linear derating factor				0.18	W/°C
Single pulse avalanche energy b			E <sub>AS</sub>	47	mJ
Maximum power dissipation $T_C = 25  ^{\circ}C$			$P_{D}$	27	W
Peak diode recovery dV/dt c			dV/dt	4.5	V/ns
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +175	°C
Soldering recommendations (peak temperature) <sup>d</sup> For 10 s				300 d	
Mounting torque	6.00 0*1	0.00 140		10	lbf ⋅ in
Mounting torque	6-32 or M3 screw			1.1	N·m

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b.  $V_{DD} = 25 \text{ V}$ , starting  $T_J = 25 \,^{\circ}\text{C}$ ,  $L = 1.47 \, \text{mH}$ ,  $R_q = 25 \, \Omega$ ,  $I_{AS} = 8.0 \, \text{A}$  (see fig. 12)
- c.  $I_{SD}$  £ 10 A,  $dI/dt \le 90$  A/ $\mu$ s,  $V_{DD} \le V_{DS}$ ,  $T_J \le 175$  °C
- d. 1.6 mm from case

S21-0454-Rev. D, 10-May-2021



# Vishay Siliconix

THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	65	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	5.5	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	,
Drain-ssource breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0$	V, I <sub>D</sub> = 250 μA	60	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I <sub>D</sub> = 1 mA	-	0.63	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$		2.0	-	4.0	V
Gate-source leakage	I <sub>GSS</sub>	V	<sub>GS</sub> = ± 20	-	-	± 100	nA
Zoro gato voltago drain current	I	V <sub>DS</sub> = 60 V, V <sub>GS</sub> = 0 V		ı	-	25	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 48 V, V	<sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	$I_D = 4.8 A^b$	-	-	0.20	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 2	5 V, I <sub>D</sub> = 4.8 A <sup>b</sup>	2.2	-	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	V	$t_{GS} = 0 \text{ V}$	1	300	-	
Output capacitance	Coss	V	<sub>DS</sub> = 25 V	1	160	-	pF
Reverse transfer capacitance	$C_{rss}$	f = 1.0	MHz, see fig. 5	i	29	-	pi
Drain to sink capacitance	С	f =	= 1.0 MHz	-	12	-	
Total gate charge	$Q_g$		1047	-	-	11	
Gate-source charge	$Q_{gs}$	V <sub>GS</sub> = 10 V	$I_D = 10 \text{ A}, V_{DS} = 48 \text{ V},$	-	-	3.1	nC
Gate-drain charge	$Q_{gd}$		see fig. 6 and 13 <sup>b</sup>	-	-	5.8	
Turn-on delay time	t <sub>d(on)</sub>			-	10	-	
Rise time	t <sub>r</sub>	V <sub>DD</sub> = 30 V, I <sub>D</sub> = 10 A		-	50	-	ns
Turn-off delay time	t <sub>d(off)</sub>	$V_{DD} = 30 \text{ V}, I_{D} = 10 \text{ A}$ $R_g = 24 \Omega, R_D = 2.7 \Omega, \text{ see fig. } 10^b$		-	13	-	
Fall time	t <sub>f</sub>	$n_g = 24 \text{ sz}, n_D = 2.7 \text{ sz}, \text{ see fig. 10}$		-	19	-	
Internal drain inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from	Between lead, 6 mm (0.25") from		4.5	-	-11
Internal source inductance	L <sub>S</sub>	package and cer die contact	nter of	-	7.5	-	nH
Drain-Source Body Diode Characteristic	cs						•
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbo showing the	I	ı	-	8.0	Α
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		ı	-	32	
Body diode voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C}, \ I_S = 8.0  \text{A}, \ V_{GS} = 0  \text{V}^{\text{b}}$		-	-	1.6	V
Body diode reverse recovery time	t <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = 10 \text{ A, di/dt} = 100 \text{ A/µs}^b$		-	70	140	ns
Body diode reverse recovery charge	Q <sub>rr</sub>	1J=25 C, IF=	10 A, α/αι = 100 A/μS°	-	0.20	0.40	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic turn-	on time is negligible (turn	on is do	minated b	by L <sub>S</sub> and	L <sub>D</sub> )

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq$  300  $\mu$ s; duty cycle  $\leq$  2 %



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

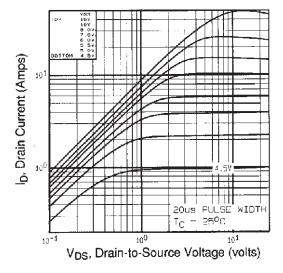


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

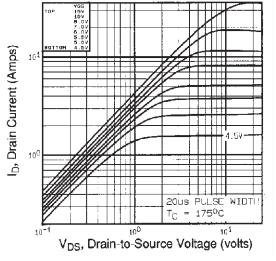


Fig. 2 - Typical Output Characteristics,  $T_C = 175$  °C

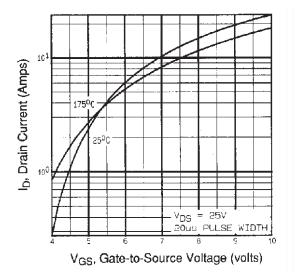


Fig. 3 - Typical Transfer Characteristics

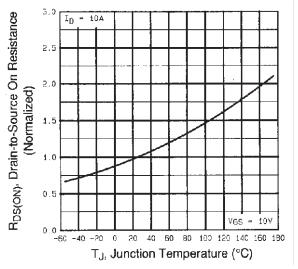


Fig. 4 - Normalized On-Resistance vs. Temperature



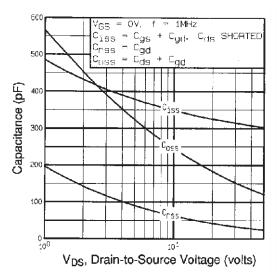


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

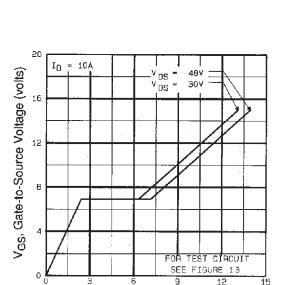


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

Q<sub>G</sub>, Total Gate Charge (nC)

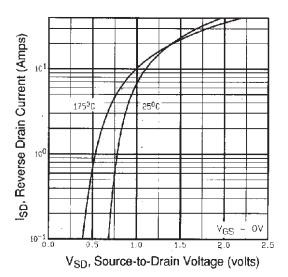
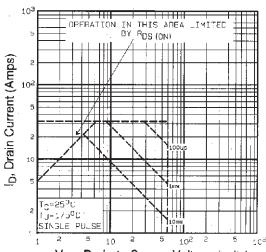


Fig. 7 - Typical Source-Drain Diode Forward Voltage



V<sub>DS</sub>, Drain-to-Source Voltage (volts) Fig. 8 - Maximum Safe Operating Area



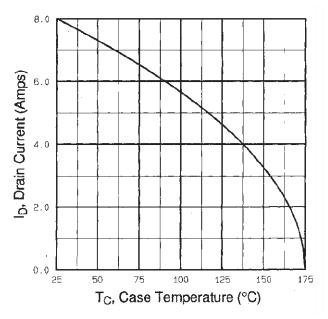


Fig. 9 - Maximum Drain Current vs. Case Temperature

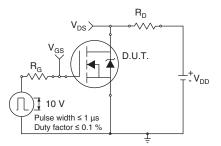


Fig. 10a - Switching Time Test Circuit

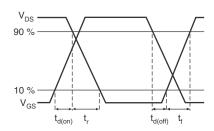


Fig. 10b - Switching Time Waveforms

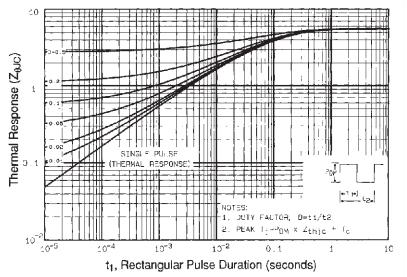


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case



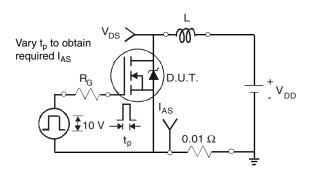


Fig. 12a - Unclamped Inductive Test Circuit

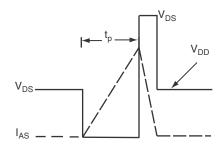


Fig. 12b - Unclamped Inductive Waveforms

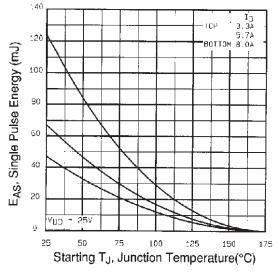


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

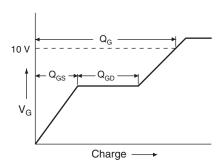


Fig. 13a - Basic Gate Charge Waveform

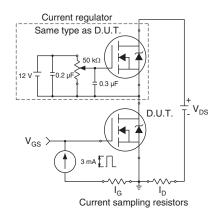
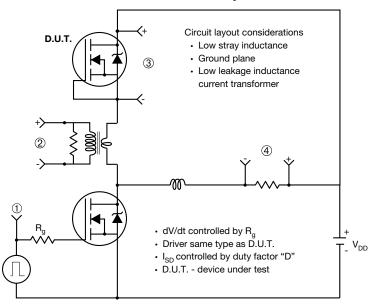


Fig. 13b - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



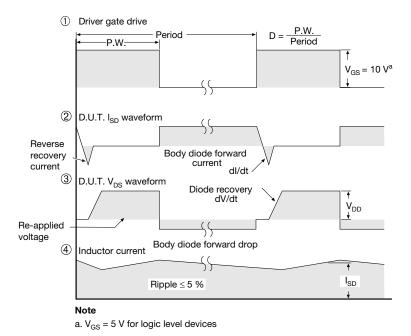


Fig. 14 - For N-Channel

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Vishay Siliconix

# **TO-220 FULLPAK (High Voltage)**

## **OPTION 1: FACILITY CODE = 9**



		MILLIMETERS	
DIM.	MIN.	NOM.	MAX.
Α	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

### **Notes**

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



## **OPTION 2: FACILITY CODE = Y**



	MILLIM	ETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
Е	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

ECN: E19-0180-Rev. D, 08-Apr-2019

DWG: 5972

### Notes

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet  $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



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Vishay

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